

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Huai-Ying Huang</td> <td>06/24/2009</td> </tr> <tr> <td>Yu-Kuan Lin</td> <td>06/24/2009</td> </tr> <tr> <td>Sheng Chiang Hung</td> <td>06/24/2009</td> </tr> <tr> <td>Feng-Ming Chang</td> <td>06/24/2009</td> </tr> <tr> <td>Jui-Lin Chen</td> <td>06/24/2009</td> </tr> <tr> <td>Ping-Wei Wang</td> <td>06/24/2009</td> </tr> </tbody> </table>		Name	Execution Date	Huai-Ying Huang	06/24/2009	Yu-Kuan Lin	06/24/2009	Sheng Chiang Hung	06/24/2009	Feng-Ming Chang	06/24/2009	Jui-Lin Chen	06/24/2009	Ping-Wei Wang	06/24/2009
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RECEIVING PARTY DATA															
Name:	Taiwan Semiconductor Manufacturing Company, Ltd.														
Street Address:	No. 8, Li-Hsin Rd. 6														
Internal Address:	Science-Based Industrial Park														
City:	Hsin-Chu														
State/Country:	TAIWAN														
Postal Code:	300-77 R.O.C.														
PROPERTY NUMBERS Total: 1															
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12727985</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12727985										
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Application Number:	12727985														
CORRESPONDENCE DATA															
Fax Number:	(972)732-9218														
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>															
Phone:	972-732-1001														
Email:	errera@slater-matsil.com														
Correspondent Name:	Slater & Matsil, L.L.P.														
Address Line 1:	17950 Preston Road														
Address Line 2:	Suite 1000														
Address Line 4:	Dallas, TEXAS 75252														
ATTORNEY DOCKET NUMBER:	TSM09-0099														

CH \$40.00 12727985

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PATENT
REEL: 024111 FRAME: 0562

NAME OF SUBMITTER:

Jill M. Errera

Total Attachments: 2

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ATTORNEY DOCKET NO.
TSM09-0099

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd. (TSMC), a corporation organized and existing under the laws of Taiwan, the Republic of China, with its principal office at No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C., is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TSMC, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TSMC, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to TSMC, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TSMC, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TSMC, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	<i>Stable SRAM Cell</i>			
SIGNATURE OF INVENTOR AND NAME	<i>Huai-Ying Huang</i> Huai-Ying Huang	<i>Yu-Kuan Lin</i> Yu-Kuan Lin	<i>Sheng-Chiang Hung</i> Sheng Chiang Hung	<i>Feng-Ming Chang</i> Feng-Ming Chang
DATE	<i>June 24, 2009</i> <i>Huai-Ying Huang</i>	<i>June 24, 2009</i>	<i>June 24, 2009</i>	<i>June 24, 2009</i> <i>Feng-Ming Chang</i>
RESIDENCE (City, County, State)	Jhonghe City, 235 Taiwan, R.O.C.	Taipei, Taiwan, R.O.C.	Hsin-Chu, 300 Taiwan, R.O.C.	Chia-yi, Taiwan, R.O.C.

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NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TSMC, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TSMC, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to TSMC, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

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IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	<i>Bit Addressable 8T+1T SRAM to Eliminate Dummy Read Disturbance</i>		
SIGNATURE OF INVENTOR AND NAME	<i>Jui-Lin Chen</i> Jui-Lin Chen	<i>Ping-Wei Wang</i> Ping-Wei Wang	
DATE	<i>June 24, 2007</i>	<i>Jun. 24, 07</i>	
RESIDENCE (City, County, State)	Taipei, 114 Taiwan, R.O.C.	Hsin-Chu Taiwan, R.O.C.	